

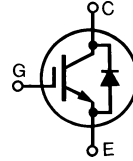
# IGBT

Combi Pack

**IXGA/IXGP12N100U1**  
**IXGA/IXGP12N100AU1**

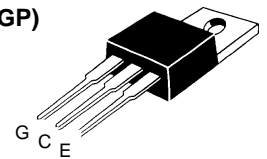
| $V_{CES}$ | $I_{C25}$ | $V_{CE(sat)}$ |
|-----------|-----------|---------------|
| 1000 V    | 24 A      | 3.5 V         |
| 1000 V    | 24 A      | 4.0 V         |

Preliminary Data Sheet

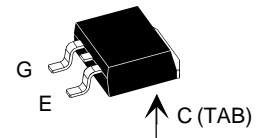


| Symbol  | Test Conditions   | Maximum Ratings                  |                  |
|---|---|----------------------------------|------------------|
| $V_{CES}$   | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$   | 1000                             | V                |
| $V_{CGR}$   | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GE} = 1\text{ M}\Omega$   | 1000                             | V                |
| $V_{GES}$   | Continuous  | $\pm 20$                         | V                |
| $V_{GEM}$   | Transient   | $\pm 30$                         | V                |
| $I_{C25}$   | $T_C = 25^\circ\text{C}$  | 24                               | A                |
| $I_{C90}$   | $T_C = 90^\circ\text{C}$  | 12                               | A                |
| $I_{CM}$  | $T_C = 25^\circ\text{C}$ , 1 ms   | 48                               | A                |
| <b>SSOA</b><br><b>(RBSOA)</b>   | $V_{GE} = 15\text{ V}$ , $T_{VJ} = 125^\circ\text{C}$ , $R_G = 150\ \Omega$<br>Clamped inductive load, $L = 300\ \mu\text{H}$ | $I_{CM} = 24$<br>@ $0.8 V_{CES}$ | A                |
| $P_C$   | $T_C = 25^\circ\text{C}$  | 100                              | W                |
| $T_J$   |   | -55 ... +150                     | $^\circ\text{C}$ |
| $T_{JM}$  |   | 150                              | $^\circ\text{C}$ |
| $T_{stg}$   |   | -55 ... +150                     | $^\circ\text{C}$ |
| $M_d$   | Mounting torque with screw M3<br>Mounting torque with screw M3.5  | 0.45/4<br>0.55/5                 | Nm/lb.in.        |
| <b>Weight</b>   |   | 4                                | g                |
| Maximum lead temperature for soldering<br>1.6 mm (0.062 in.) from case for 10 s |   | 300                              | $^\circ\text{C}$ |

**TO-220AB(IXGP)**



**TO-263 AA (IXGA)**



## Features

- International standard packages JEDEC TO-220AB and TO-263AA
- IGBT with antiparallel FRED in one package
- Second generation HDMOS™ process
- Low  $V_{CE(sat)}$ 
  - for minimum on-state conduction losses
- MOS Gate turn-on
  - drive simplicity
- Fast Recovery Epitaxial Diode (FRED)
  - soft recovery with low  $I_{RM}$

## Applications

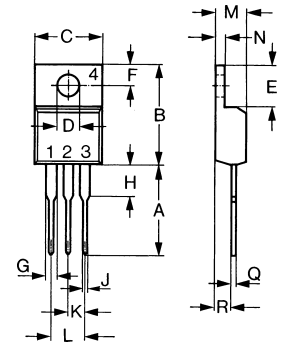
- AC motor speed control
- DC servo and robot drives
- DC choppers
- Uninterruptible power supplies (UPS)
- Switch-mode and resonant-mode power supplies

## Advantages

- Easy to mount with one screw
- Space savings (two devices in one package)
- Reduces assembly time and cost
- High power density

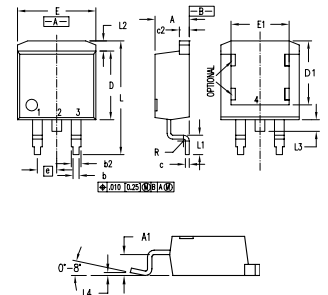
| Symbol        | Test Conditions                                     | Characteristic Values     |      |                     |
|---------------|---|---------------------------|------|---------------------|
|               |   | Min.                      | Typ. | Max.                |
| $BV_{CES}$    | $I_C = 3\text{ mA}$ , $V_{GE} = 0\text{ V}$         | 1000                      |      | V                   |
| $V_{GE(th)}$  | $I_C = 250\ \mu\text{A}$ , $V_{GE} = V_{GE}$        | 2.5                       |      | V                   |
| $I_{CES}$     | $V_{CE} = 0.8$ , $V_{CES}$<br>$V_{GE} = 0\text{ V}$ | $T_J = 25^\circ\text{C}$  |      | 300 $\mu\text{A}$   |
|               |   | $T_J = 125^\circ\text{C}$ |      | 3 mA                |
| $I_{GES}$     | $V_{CE} = 0\text{ V}$ , $V_{GE} = \pm 20\text{ V}$  |                           |      | $\pm 100\text{ nA}$ |
| $V_{CE(sat)}$ | $I_C = I_{CE90}$ , $V_{GE} = 15$                    | 12N100                    |      | 3.5 V               |
|               |   | 12N100A                   |      | 4.0 V               |

| Symbol   | Test Conditions   | Characteristic Values |      |      |
|--|---|-----------------------|------|------|
|  |   | Min.                  | Typ. | Max. |
| $(T_J = 25^\circ\text{C}, \text{ unless otherwise specified})$ |   |                       |      |      |
| $g_{fs}$   | $I_C = I_{C90}; V_{CE} = 10\text{ V},$<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $\leq 2\%$   | 6                     | 10   | S    |
| $Q_g$  | $I_C = I_{C90}; V_{GE} = 15\text{ V}, V_{CE} = 0.5 V_{CES}$   |                       | 65   | 90   |
| $Q_{ge}$   |   |                       | 8    | 20   |
| $Q_{gc}$   |   |                       | 24   | 45   |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = I_{C90}, V_{GE} = 15\text{ V}, L = 300\ \mu\text{H}$<br>$V_{CE} = 800\text{ V}, R_G = R_{off} = 120\ \Omega$<br>Remarks: Switching times may increase for $V_{CE} (\text{Clamp}) > 0.8 V_{CES}$ , higher $T_J$ or increased $R_G$  |                       | 100  | ns   |
| $t_{ri}$   |   |                       | 200  | ns   |
| $t_{d(off)}$   |   |                       | 850  | 1000 |
| $t_{fi}$   |   | 12N100A               | 500  | 700  |
|  |   | 12N100                | 800  | 1000 |
| $E_{off}$  |   | 12N100A               | 4    | 6    |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 125^\circ\text{C}</math></b><br>$I_C = I_{C90}, V_{GE} = 15\text{ V}, L = 300\ \mu\text{H}$<br>$V_{CE} = 800\text{ V}, R_G = R_{off} = 120\ \Omega$<br>Remarks: Switching times may increase for $V_{CE} (\text{Clamp}) > 0.8 V_{CES}$ , higher $T_J$ or increased $R_G$ |                       | 100  | ns   |
| $t_{ri}$   |   |                       | 200  | ns   |
| $E_{on}$   |   |                       | 1.1  | mJ   |
| $t_{d(off)}$   |   | 12N100A               | 900  | ns   |
| $t_{fi}$   |   | 12N100                | 950  | ns   |
| $E_{off}$  |   | 12N100A               | 8    | mJ   |
|  | 12N100  | 10                    | mJ   |      |
| $R_{thJC}$   |   |                       | 1.25 | K/W  |
| $R_{thCK}$   |   | 0.25                  |      | K/W  |

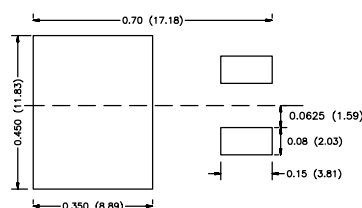
**TO-220 AB (IXGP) Outline**


| Dim. | Millimeter |       | Inches |       |
|------|------------|-------|--------|-------|
|      | Min.       | Max.  | Min.   | Max.  |
| A    | 12.70      | 13.97 | 0.500  | 0.550 |
| B    | 14.73      | 16.00 | 0.580  | 0.630 |
| C    | 9.91       | 10.66 | 0.390  | 0.420 |
| D    | 3.54       | 4.08  | 0.139  | 0.161 |
| E    | 5.85       | 6.85  | 0.230  | 0.270 |
| F    | 2.54       | 3.18  | 0.100  | 0.125 |
| G    | 1.15       | 1.65  | 0.045  | 0.065 |
| H    | 2.79       | 5.84  | 0.110  | 0.230 |
| J    | 0.64       | 1.01  | 0.025  | 0.040 |
| K    | 2.54       | BSC   | 0.100  | BSC   |
| M    | 4.32       | 4.82  | 0.170  | 0.190 |
| N    | 1.14       | 1.39  | 0.045  | 0.055 |
| Q    | 0.35       | 0.56  | 0.014  | 0.022 |
| R    | 2.29       | 2.79  | 0.090  | 0.110 |

| Reverse Diode (FRED)   |   | Characteristic Values |      |      |
|--|---|-----------------------|------|------|
| $(T_J = 25^\circ\text{C}, \text{ unless otherwise specified})$ |   |                       |      |      |
| Symbol   | Test Conditions   | Min.                  | Typ. | Max. |
| $V_F$  | $I_F = 8\text{ A}, V_{GE} = 0\text{ V},$<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |                       |      | 2.75 |
| $I_{RM}$   | $I_F = I_{C90}, V_{GE} = 0\text{ V}, -di_F/dt = 100\text{ A}/\mu\text{s}$                                   |                       | 6.5  | A    |
| $t_{rr}$   | $V_R = 100\text{ V}, T_J = 125^\circ\text{C}$   |                       | 140  | ns   |
|  | $I_F = 1\text{ A}, -di/dt = 50\text{ A}/\mu\text{s}, V_R = 30\text{ V}, T_J = 25^\circ\text{C}$             |                       | 50   | 60   |
| $R_{thJC}$   |   |                       |      | 2.5  |

**TO-263 AA (IXGA) Outline**


| Dim. | Millimeter |       | Inches |      |
|------|------------|-------|--------|------|
|      | Min.       | Max.  | Min.   | Max. |
| A    | 4.06       | 4.83  | .160   | .190 |
| A1   | 2.03       | 2.79  | .080   | .110 |
| b    | 0.51       | 0.99  | .020   | .039 |
| b2   | 1.14       | 1.40  | .045   | .055 |
| c    | 0.46       | 0.74  | .018   | .029 |
| c2   | 1.14       | 1.40  | .045   | .055 |
| D    | 8.64       | 9.65  | .340   | .380 |
| D1   | 7.11       | 8.13  | .280   | .320 |
| E    | 9.65       | 10.29 | .380   | .405 |
| E1   | 6.86       | 8.13  | .270   | .320 |
| e    | 2.54       | BSC   | .100   | BSC  |
| L    | 14.61      | 15.88 | .575   | .625 |
| L1   | 2.29       | 2.79  | .090   | .110 |
| L2   | 1.02       | 1.40  | .040   | .055 |
| L3   | 1.27       | 1.78  | .050   | .070 |
| L4   | 0          | 0.38  | 0      | .015 |
| R    | 0.46       | 0.74  | .018   | .029 |

**Min. Recommended Footprint**


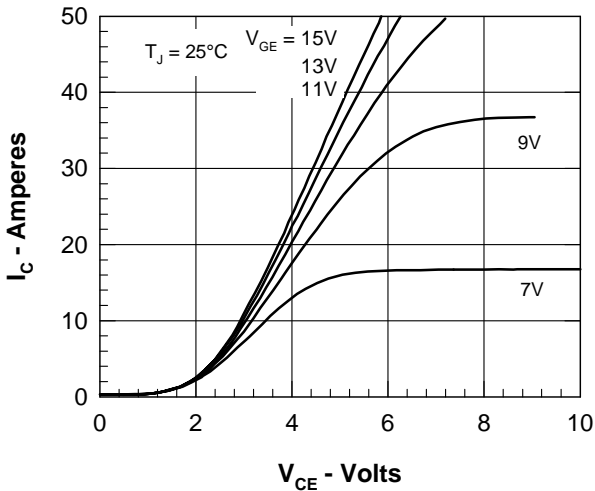


Figure 1. Saturation Voltage Characteristics

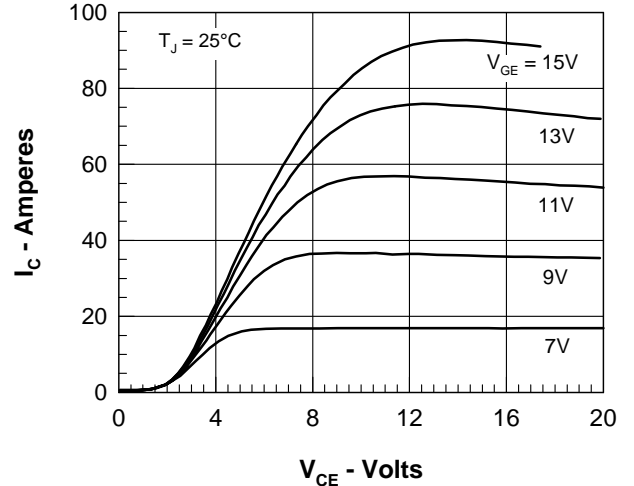


Figure 2. Extended Output Characteristics

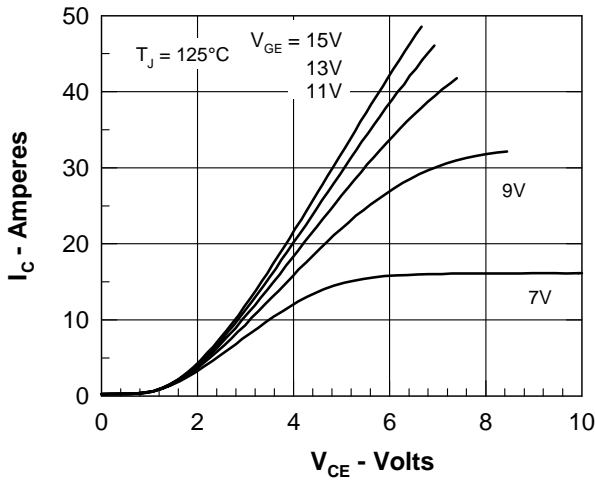


Figure 3. Saturation Voltage Characteristics

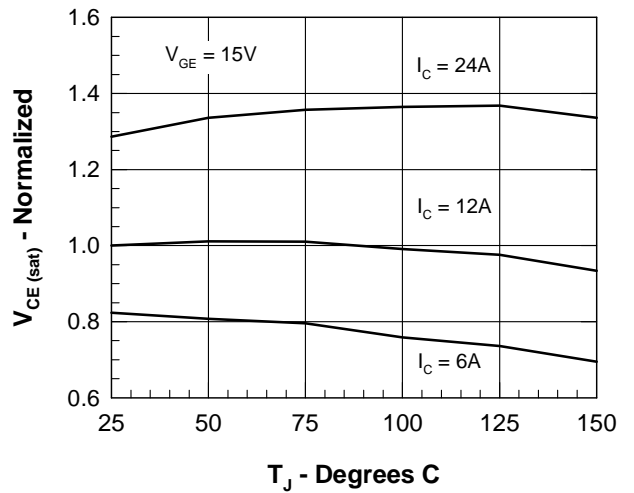


Figure 4. Temperature Dependence of  $V_{CE(sat)}$

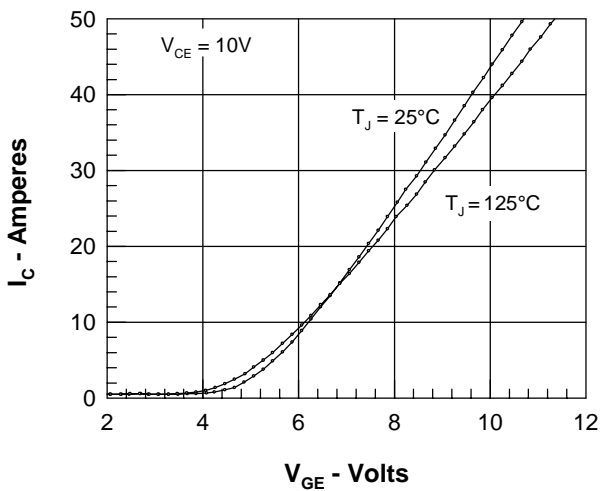


Figure 5. Admittance Curves

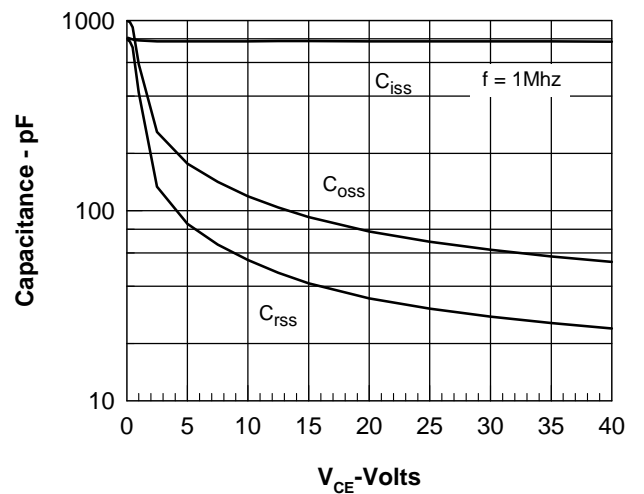


Figure 6. Capacitance Curves

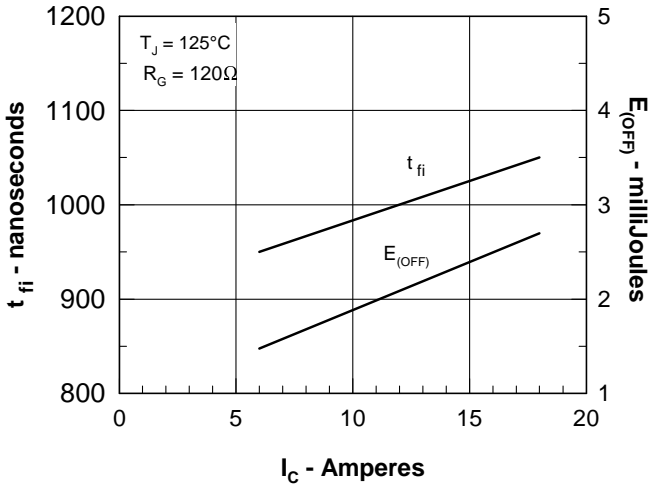


Figure 7. Dependence of  $t_{fi}$  and  $E_{OFF}$  on  $I_C$ .

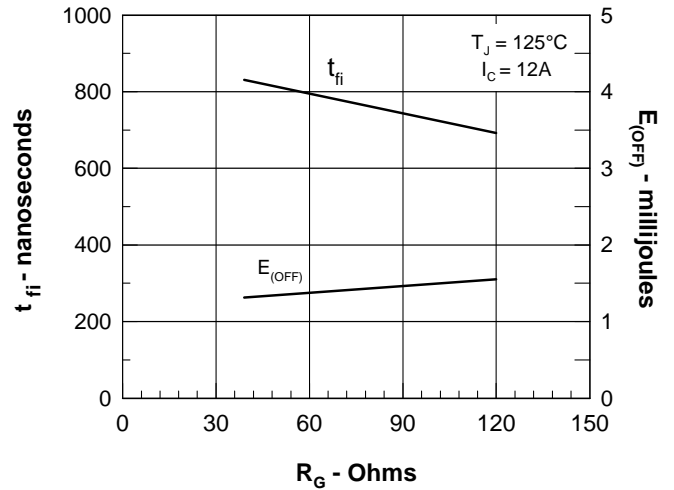


Figure 8. Dependence of  $t_{fi}$  and  $E_{OFF}$  on  $R_G$ .

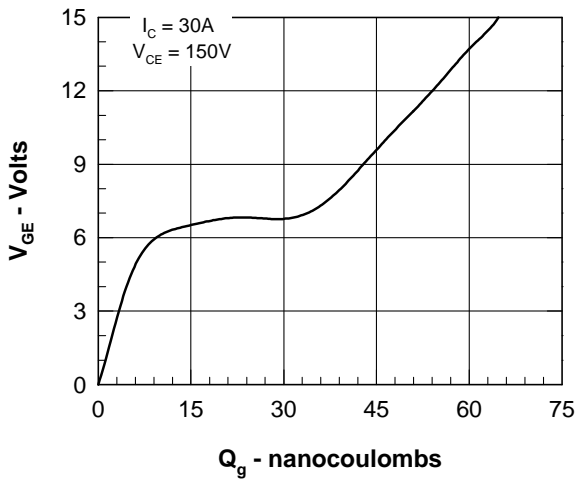


Figure 9. Gate Charge

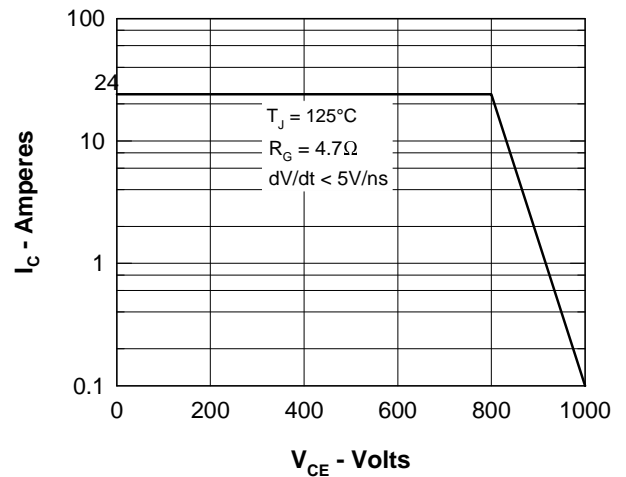


Figure 10. Turn-off Safe Operating Area

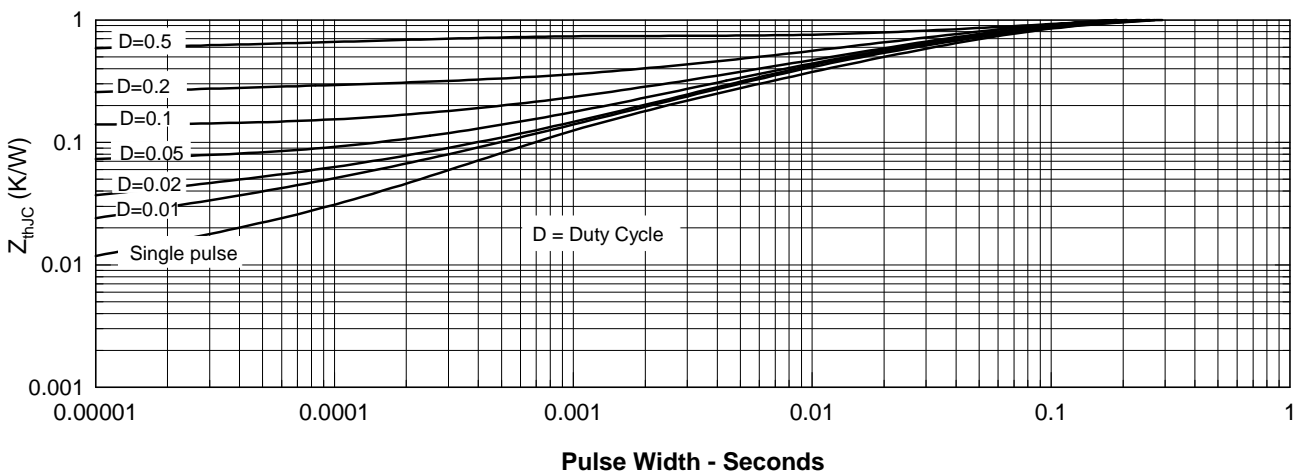


Figure 11. Transient Thermal Resistance